

2N7636-GA

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650 V

1.7 V

425 mΩ

4 A

Normally – OFF Silicon Carbide Junction Transistor

Features

- 250 °C maximum operating temperature
- Temperature independent switching performance
- Gate oxide free SiC switch
- Suitable for connecting an anti-parallel diode
- · Positive temperature coefficient for easy paralleling
- Low gate charge

Advantages

• Low switching losses

• Higher efficiency

High temperature operation

· High short circuit withstand capability

· Low intrinsic capacitance

Package

RoHS Compliant





SMD0.5 / TO – 276 (Hermetic Package)

Applications

• Down Hole Oil Drilling, Geothermal Instrumentation

V_{DS}

V_{DS(ON)}

R_{DS(ON)}

- Hybrid Electric Vehicles (HEV)
- Solar Inverters
- Switched-Mode Power Supply (SMPS)
- Power Factor Correction (PFC)
- Induction Heating
- Uninterruptible Power Supply (UPS)
- Motor Drives

Maximum Ratings at T_i = 250 °C, unless otherwise specified

J j		•		
Parameter	Symbol	Conditions	Values	Unit
Drain – Source Voltage	V _{DS}	$V_{GS} = 0 V$	650	V
Continuous Drain Current	I _D	T _C = 165 °C	4	А
Gate Peak Current	I _{GM}		5	А
Reverse Gate – Source Voltage	V _{GS}		30	V
Reverse Drain – Source Voltage	V _{DS}		40	V
Power Dissipation	P _{tot}	T _C = 25 °C	7	W
Operating and Storage Temperature	T _j , T _{stg}		-55 to 250	°C

Electrical Characteristics at T_i = 250 °C, unless otherwise specified

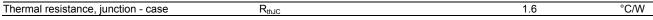
Parameter	Symbol	0	Values			11
		Conditions	min.	typ.	max.	Unit
On Characteristics						
		I _D = 4 A, I _G = 100 mA, T _j = 25 °C		1.7	2.2	
Drain – Source On Voltage	V _{DS(ON)}	I _D = 4 A, I _G = 250 mA, T _j = 175 °C		3.2	4.0	V
-		I _D = 4 A, I _G = 250 mA, T _j = 250 °C		4.7	5.5	
Drain – Source On Resistance	R _{DS(ON)}	I _D = 4 A, I _G = 100 mA, T _j = 25 °C		425		
		I _D = 4 A, I _G = 250 mA, T _j = 175 °C		800		mΩ
		I _D = 4 A, I _G = 250 mA, T _j = 250 °C		1180		
Gate Forward Voltage	$V_{GS(FWD)}$	I _G = 500 mA, T _j = 25 °C		3.3		V
		I _G = 500 mA, T _j = 250 °C		3.2		v
DC Current Gain	β	V _{DS} = 5 V, I _D = 5 A, T _j = 25 °C	90	110		
		V_{DS} = 5 V, I_D = 5 A, T_j = 250 °C	60	80		
Off Characteristics						
Drain Leakage Current		V _R = 650 V, V _{GS} = 0 V, T _j = 25 °C		0.1	10	
	I _{DSS}	V _R = 650 V, V _{GS} = 0 V, T _j = 175 °C		1	50	μA
		$V_{R} = 650 \text{ V}, V_{GS} = 0 \text{ V}, T_{i} = 250 ^{\circ}\text{C}$		10	100	•

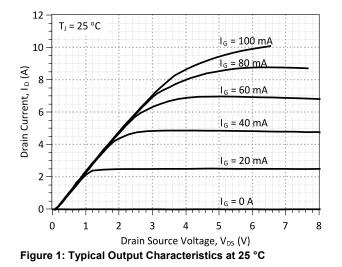


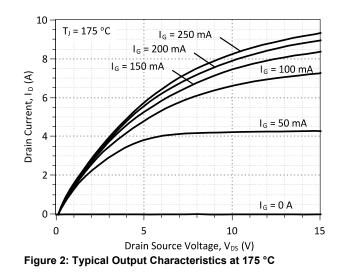
2N7636-GA

Electrical Characteristics at T_j = 250 °C, unless otherwise specified

Parameter	Symbol	Conditions	Values		11	
		Conditions	min.	typ.	max.	Unit
Dynamic Characteristics						
Input Capacitance	C _{iss}	V _{DS} = 35 V, V _{GS} = 0 V, f = 1 MHz, T _{vj} = 25 °C		324		pF
Output Capacitance	C _{oss}			45		pF
Reverse Transfer Capacitance	C _{rss}			45		pF
Switching Characteristics						
Turn On Delay Time	t _{d(on)}	$\label{eq:V_DD} \begin{array}{l} V_{DD} = 400 \; V, \; I_D = 5 \; A, \\ R_{G(on)} = R_{G(off)} = 44 \; \Omega, \\ V_{GS} = -8/15 \; V, \; T_j = 175 \; ^{\circ}\text{C} \\ \text{Refer to Figure 10 for gate drive} \\ \text{current waveforms} \end{array}$		5		ns
Rise Time	tr			15		ns
Turn Off Delay Time	t _{d(off)}			74		ns
Fall Time	t _f			14		ns
Turn-On Energy Per Pulse	Eon			24		μJ
Turn-Off Energy Per Pulse	E _{off}			7		μJ
Total Switching Energy	E _{ts}			31		μJ
Turn On Delay Time	t _{d(on)}	$\label{eq:V_DD} \begin{array}{l} V_{DD} = 400 \; V, \; I_D = 5 \; A, \\ R_{G(on)} = R_{G(off)} = 44 \; \Omega, \\ V_{GS} = -8/15 \; V, \; T_j = 250 \; ^{\circ}\text{C} \\ \text{Refer to Figure 10 for gate drive} \\ \text{current waveforms} \end{array}$		9		ns
Rise Time	t,			24		ns
Turn Off Delay Time	t _{d(off)}			114		ns
Fall Time	t _f			17		ns
Turn-On Energy Per Pulse	Eon			54		μJ
Turn-Off Energy Per Pulse	E _{off}			10		μJ
Total Switching Energy	E _{ts}			64		μJ







GeneSiC

2N7636-GA

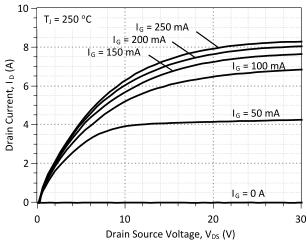


Figure 3: Typical Output Characteristics at 250 °C

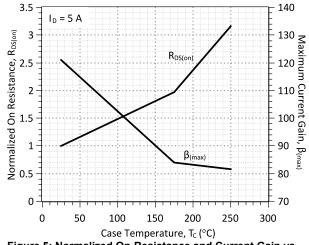
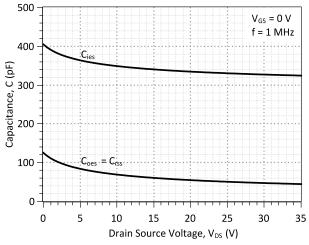
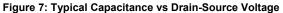


Figure 5: Normalized On-Resistance and Current Gain vs. Temperature





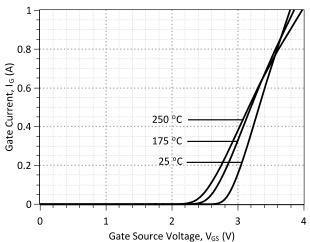


Figure 4: Typical Gate Source I-V Characteristics vs. Temperature

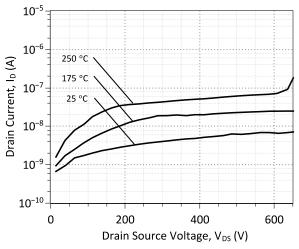
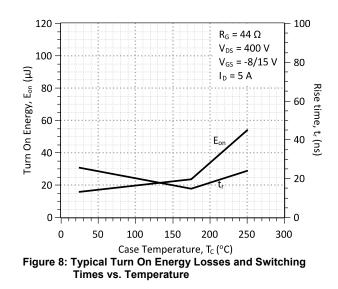
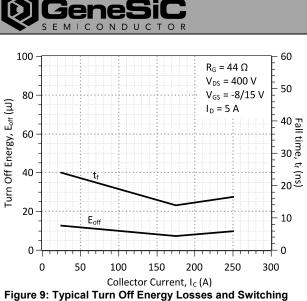
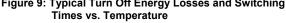
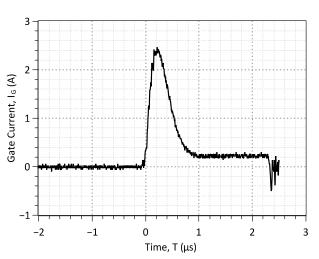


Figure 6: Typical Blocking Characteristics





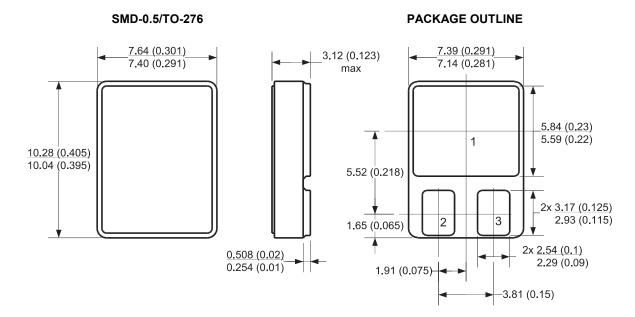




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Figure 10: Typical Gate-Source Switching Waveforms

Package Dimensions:



NOTE

CONTROLLED DIMENSION IS INCH. DIMENSION IN BRACKET IS MILLIMETER.
 DIMENSIONS DO NOT INCLUDE END FLASH, MOLD FLASH, MATERIAL PROTRUSIONS



Revision History					
Date	Revision	Comments Supersede			
2013/11/18	1	Updated Electrical Characteristics			
2012/08/24	0	Initial release			

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SPICE Model Parameters

Copy the following code into a SPICE software program for simulation of the 2N7636-GA device.

```
*
     MODEL OF GeneSiC Semiconductor Inc.
*
*
     $Revision: 1.0
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*
     $Date: 06-SEP-2013
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*
*
    GeneSiC Semiconductor Inc.
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*
* These models are provided "AS IS, WHERE IS, AND WITH NO WARRANTY
* OF ANY KIND EITHER EXPRESSED OR IMPLIED, INCLUDING BUT NOT LIMITED
* TO ANY IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A
* PARTICULAR PURPOSE."
* Models accurate up to 2 times rated drain current.
.model 2N7636 NPN
+ IS
       1.22E-47
+ ISE
          3.91E-27
+ EG
          3.23
+ BF
         110
+ BR
         0.55
         999
+ IKF
+ NF
         1
         2.022
+ NE
+ RB
         0.26
+ RE
         0.231
+ RC
         0.16
         1.37E-10
+ CJC
+ VJC
         3.173990516
+ MJC
          0.436428533
+ CJE
         3.36E-10
+ VJE
         2.944816511
        0.493905327
+ MJE
+ XTI
         3
+ XTB
          -0.45
+ TRC1
          1.50E-02
+ VCEO 650
+ ICRATING 4
+ MFG GeneSiC Semiconductor
* End of 2N7636-GA SPICE Model
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